

SMD Comm X7R Flex, Ceramic, 0.056 uF, 5%, 200 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 0805



Dimensions	
Chip Size	0805
L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
T	1.25mm +/-0.15mm
S	0.75mm MIN
B	0.5mm +/-0.25mm

Packaging Specifications	
Packaging:	T&R, 330mm, Plastic Tape
Packaging Quantity:	10000

General Information	
Series:	SMD Comm X7R Flex
Style:	SMD Chip
Description:	SMD, MLCC, FT-CAP, Temperature Stable
Features:	FT-CAP, Temperature Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	21 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	0.056 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	5%
Voltage DC:	200 VDC
Dielectric Withstanding Voltage:	500 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms
Dissipation Factor:	2.5% 1 kHz 1.0Vrms
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance:	17.8571 GOhms

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